

**IN THE CLAIMS:**

Please ADD claims 21-26, as follows. For the Examiner's convenience, all claims currently pending in this application have been reproduced below:

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17. (Previously Added) A scanning exposure apparatus, comprising:

a projection optical system for projecting a pattern of a reticle onto an object to be exposed, wherein the object has a region in which a pattern structure is formed;


a moving system for scanningly moving the reticle and the object relative to said projection optical system, wherein the pattern of the reticle is scanningly projected onto the object in a scanningly moving state;

surface position detecting means for detecting a surface position of the object at each of plural detection points in the region, in the scanningly moving state;

surface position adjusting means for adjusting the surface position of the object with respect to an image plane of said projection optical system, on the basis of the detection by said surface position detecting means in the projection;

control means for controlling said moving system and said surface position detecting means to perform a pre-scan measurement of the surface position of the object, prior to the projection, so as to detect an error, related to the detection through said surface position detecting means, with respect to each of the detection points, which error is attributable to a difference in pattern structure at the detection points in the region, the detected error being used for correcting the adjustment by said surface position adjusting means in the projection; and

initializing means for initializing said surface position detecting means in synchronism with the scan motion in the projection, at the position where said surface position detecting means has started the detection in the pre-scan measurement.



18. (Previously Added) An apparatus according to Claim 17, wherein said surface position detecting means performs detection in accordance with a predetermined cycle, and wherein the detection points in the projection coincide with positions detected by said surface position detecting means in the pre-scan measurement, by initializing said surface position detecting means through said initializing means.

19. (Previously Added) An apparatus according to Claim 17, wherein said surface position detecting means includes light projection means for projecting light obliquely onto the object and an accumulation type sensor for receiving reflection light from the object, and wherein said initializing means performs initialization of said surface position detecting means by resetting the accumulation start timing of said sensor.

20. (Previously Added) A device manufacturing method, comprising the steps of:  
projecting a pattern of a reticle onto an object to be exposed, by use of a projection optical system, wherein the object has a region in which a pattern structure is formed;

scanningly moving the reticle and the object relative to the projection optical system, wherein the pattern of the reticle is scanningly projected onto the object in a scanningly moving state;

adjusting the surface position of the object with respect to an image plane of the projection optical system, on the basis of the surface position detection in the projection;

performing a pre-scan measurement of the surface position of the object, prior to the projection, by use of the surface position detecting means, so as to detect an error, related to the detection through the surface position detecting means, with respect to each of the detection points, which error is attributable to a difference in pattern structure at the detection points in the region, the detected error being used for correcting the adjustment in the projection;

initializing the surface position detecting means in synchronism with the scan motion in the projection, at a position where the surface position detecting means has started the detection in the pre-scan measurement; and

processing the object having the reticle pattern projected thereon, so as to form a circuit pattern thereon.

21. (New) A scanning exposure apparatus comprising:

a stage unit on which an object to be exposed is to be placed, said stage unit being arranged to move the object;

a position detecting unit for detecting a position of a surface of the object, while the object is moved by said stage unit; and

a control unit being arranged to obtain correction data serviceable to correct a result of a detection made by said position detecting unit in association with said stage unit, wherein said position detecting unit is initialized for the detection of the position of the surface of the object, on the basis of the position of the object being moved by said stage unit.

22. (New) An apparatus according to Claim 21, wherein said position detecting unit includes an image sensor, and said position detecting unit is initialized by refreshing said image sensor.

23. (New) A device manufacturing method comprising:  
exposing an object to a pattern, by use of a scanning exposure apparatus as recited in Claim 21.

24. (New) A scanning exposure apparatus comprising:  
a stage unit on which an object to be exposed is to be placed, said stage unit being arranged to move the object; and  
a position detecting unit for detecting a position of a surface of the object, while the object is moved by said stage unit,  
wherein said position detecting unit is initialized for the detection of the position of the surface of the object, on the basis of the position of the object being moved by said stage unit.

25. (New) An apparatus according to Claim 24, wherein said position detecting unit includes an image sensor and said position detecting unit is initialized by refreshing said image sensor.

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26. (New) A device manufacturing method comprising:  
exposing an object to a pattern, by use of a scanning exposure apparatus as recited in Claim 24.

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